

# Dual Inverter

## NL27WZ04

The NL27WZ04 is a high performance dual inverter operating from a 1.65 to 5.5 V supply.

### Features

- Designed for 1.65 V to 5.5 V  $V_{CC}$  Operation
- 2.0 ns  $t_{PD}$  at  $V_{CC} = 5$  V (Typ)
- Inputs/Outputs Overvoltage Tolerant up to 5.5 V
- $I_{OFF}$  Supports Partial Power Down Protection
- Sink 32 mA at 4.5 V
- Available in SC-88, SC-74 and UDFN6 Packages
- Chip Complexity < 100 FETs
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

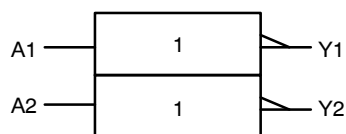
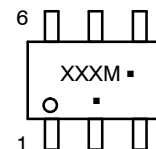


Figure 1. Logic Symbol

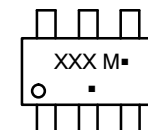
### MARKING DIAGRAMS



SC-88  
DF SUFFIX  
CASE 419B



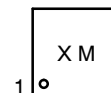
SC-74  
CASE 318F-05



UDFN6  
1.45 x 1.0  
CASE 517AQ



UDFN6  
1.0 x 1.0  
CASE 517BX



X, XXX = Specific Device Code  
M = Date Code\*  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

### ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

# NL27WZ04

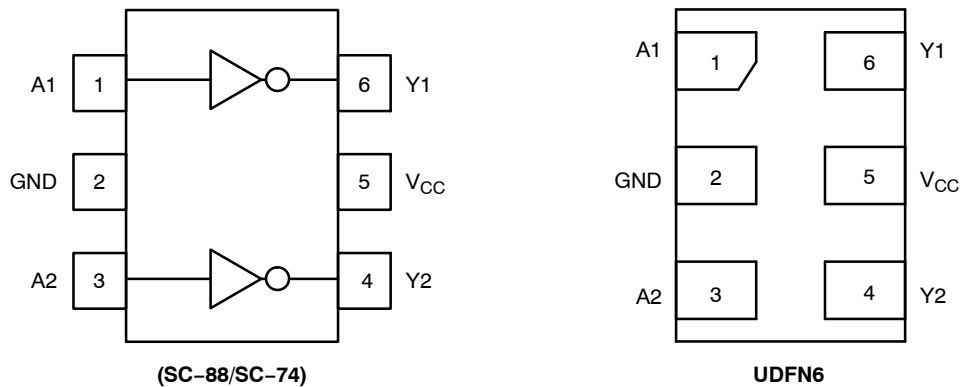


Figure 2. Pinout (Top View)

## PIN ASSIGNMENT

| Pin | Function        |
|-----|-----------------|
| 1   | A1              |
| 2   | GND             |
| 3   | A2              |
| 4   | Y2              |
| 5   | V <sub>CC</sub> |
| 6   | Y1              |

## FUNCTION TABLE

| A Input | Y Output |
|---------|----------|
| L       | H        |
| H       | L        |

# MAXIMUM RATINGS

| Symbol                              | Characteristics                                                                                                            | Value                                                         | Unit |
|-------------------------------------|----------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------|------|
| V <sub>CC</sub>                     | DC Supply Voltage                                                                                                          | −0.5 to +6.5                                                  | V    |
| V <sub>IN</sub>                     | DC Input Voltage                                                                                                           | −0.5 to +6.5                                                  | V    |
| V <sub>OUT</sub>                    | DC Output Voltage<br>Active-Mode (High or Low State)<br>Tri-State Mode (Note 1)<br>Power-Down Mode (V <sub>CC</sub> = 0 V) | −0.5 to V <sub>CC</sub> + 0.5<br>−0.5 to +6.5<br>−0.5 to +6.5 | V    |
| I <sub>IK</sub>                     | DC Input Diode Current<br>V <sub>IN</sub> < GND                                                                            | −50                                                           | mA   |
| I <sub>OK</sub>                     | DC Output Diode Current<br>V <sub>OUT</sub> < GND                                                                          | −50                                                           | mA   |
| I <sub>OUT</sub>                    | DC Output Source/Sink Current                                                                                              | ±50                                                           | mA   |
| I <sub>CC</sub> or I <sub>GND</sub> | DC Supply Current per Supply Pin or Ground Pin                                                                             | ±100                                                          | mA   |
| T <sub>STG</sub>                    | Storage Temperature Range                                                                                                  | −65 to +150                                                   | °C   |
| T <sub>L</sub>                      | Lead Temperature, 1 mm from Case for 10 secs                                                                               | 260                                                           | °C   |
| T <sub>J</sub>                      | Junction Temperature Under Bias                                                                                            | +150                                                          | °C   |
| θ <sub>JA</sub>                     | Thermal Resistance (Note 2)<br>SC-88<br>SC-74<br>UDFN6                                                                     | 377<br>320<br>154                                             | °C/W |
| P <sub>D</sub>                      | Power Dissipation in Still Air<br>SC-88<br>SC-74<br>UDFN6                                                                  | 332<br>390<br>812                                             | mW   |
| MSL                                 | Moisture Sensitivity                                                                                                       | Level 1                                                       | –    |
| F <sub>R</sub>                      | Flammability Rating<br>Oxygen Index: 28 to 34                                                                              | UL 94 V-0 @ 0.125 in                                          | –    |
| V <sub>ESD</sub>                    | ESD Withstand Voltage (Note 3)<br>Human Body Model<br>Charged Device Model<br>(NLV) Charged Device Model                   | 2000<br>1000<br>N/A                                           | V    |
| I <sub>Latchup</sub>                | Latchup Performance (Note 4)                                                                                               | ±100                                                          | mA   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Applicable to devices with outputs that may be tri-stated.
2. Measured with minimum pad spacing on an FR4 board, using 10mm-by-1inch, 2 ounce copper trace no air flow per JESD51-7.
3. HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to EIA/JESD22-C101-F. JEDEC recommends that ESD qualification to EIA/JESD22-A115-A (Machine Model) be discontinued per JEDEC/JEP172A.
4. Tested to EIA/JESD78 Class II.

# RECOMMENDED OPERATING CONDITIONS

| Symbol                          | Characteristics                                                                                                                                                            | Min              | Max                           | Unit |
|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------|-------------------------------|------|
| V <sub>CC</sub>                 | Positive DC Supply Voltage                                                                                                                                                 | 1.65             | 5.5                           | V    |
| V <sub>IN</sub>                 | DC Input Voltage                                                                                                                                                           | 0                | 5.5                           | V    |
| V <sub>OUT</sub>                | DC Output Voltage<br>Active-Mode (High or Low State)<br>Tri-State Mode (Note 1)<br>Power-Down Mode (V <sub>CC</sub> = 0 V)                                                 | 0<br>0<br>0      | V <sub>CC</sub><br>5.5<br>5.5 |      |
| T <sub>A</sub>                  | Operating Temperature Range                                                                                                                                                | −55              | +125                          | °C   |
| t <sub>r</sub> , t <sub>f</sub> | Input Rise and Fall Time<br>V <sub>CC</sub> = 1.65 V to 1.95 V<br>V <sub>CC</sub> = 2.3 V to 2.7 V<br>V <sub>CC</sub> = 3.0 V to 3.6 V<br>V <sub>CC</sub> = 4.5 V to 5.5 V | 0<br>0<br>0<br>0 | 20<br>20<br>10<br>5           | ns/V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

| Symbol           | Parameter                 | Condition                                            | V <sub>CC</sub> (V) | T <sub>A</sub> = 25 °C |                 |                        | - 55 °C ≤ T <sub>A</sub> ≤ 125 °C |                        | Units |
|------------------|---------------------------|------------------------------------------------------|---------------------|------------------------|-----------------|------------------------|-----------------------------------|------------------------|-------|
|                  |                           |                                                      |                     | Min                    | Typ             | Max                    | Min                               | Max                    |       |
| V <sub>IH</sub>  | High-Level Input Voltage  |                                                      | 1.65 to 1.95        | 0.65 x V <sub>CC</sub> | –               | –                      | 0.65 x V <sub>CC</sub>            | –                      | V     |
|                  |                           |                                                      | 2.3 to 5.5          | 0.70 x V <sub>CC</sub> | –               | –                      | 0.70 x V <sub>CC</sub>            | –                      |       |
| V <sub>IL</sub>  | Low-Level Input Voltage   |                                                      | 1.65 to 1.95        | –                      | –               | 0.35 x V <sub>CC</sub> | –                                 | 0.35 x V <sub>CC</sub> | V     |
|                  |                           |                                                      | 2.3 to 5.5          | –                      | –               | 0.30 x V <sub>CC</sub> | –                                 | 0.30 x V <sub>CC</sub> |       |
| V <sub>OH</sub>  | High-Level Output Voltage | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> | 1.65 to 5.5         | V <sub>CC</sub> – 0.1  | V <sub>CC</sub> | –                      | V <sub>CC</sub> – 0.1             | –                      | V     |
|                  |                           | I <sub>OH</sub> = –100 μA                            | 1.65                | 1.29                   | 1.52            | –                      | 1.29                              | –                      |       |
|                  |                           | I <sub>OH</sub> = –4 mA                              | 2.3                 | 1.9                    | 2.1             | –                      | 1.9                               | –                      |       |
|                  |                           | I <sub>OH</sub> = –8 mA                              | 2.7                 | 2.2                    | 2.4             | –                      | 2.2                               | –                      |       |
|                  |                           | I <sub>OH</sub> = –12 mA                             | 3                   | 2.4                    | 2.7             | –                      | 2.4                               | –                      |       |
|                  |                           | I <sub>OH</sub> = –16 mA                             | 3                   | 2.3                    | 2.5             | –                      | 2.3                               | –                      |       |
|                  |                           | I <sub>OH</sub> = –24 mA                             | 4.5                 | 3.8                    | 4               | –                      | 3.8                               | –                      |       |
|                  |                           | I <sub>OH</sub> = –32 mA                             |                     |                        |                 |                        |                                   |                        |       |
| V <sub>OL</sub>  | Low-Level Output Voltage  | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> | 1.65 to 5.5         | –                      | –               | 0.1                    | –                                 | 0.1                    | V     |
|                  |                           | I <sub>OH</sub> = 100 μA                             | 1.65                | –                      | 0.08            | 0.24                   | –                                 | 0.24                   |       |
|                  |                           | I <sub>OH</sub> = 4 mA                               | 2.3                 | –                      | 0.12            | 0.3                    | –                                 | 0.3                    |       |
|                  |                           | I <sub>OH</sub> = 8 mA                               | 2.7                 | –                      | 0.2             | 0.4                    | –                                 | 0.4                    |       |
|                  |                           | I <sub>OH</sub> = 12 mA                              | 3                   | –                      | 0.24            | 0.4                    | –                                 | 0.4                    |       |
|                  |                           | I <sub>OH</sub> = 16 mA                              | 3                   | –                      | 0.26            | 0.55                   | –                                 | 0.55                   |       |
|                  |                           | I <sub>OH</sub> = 24 mA                              | 4.5                 | –                      | 0.31            | 0.55                   | –                                 | 0.55                   |       |
|                  |                           | I <sub>OH</sub> = 32 mA                              |                     |                        |                 |                        |                                   |                        |       |
| I <sub>IN</sub>  | Input Leakage Current     | V <sub>IN</sub> = 5.5 V or GND                       | 1.65 to 5.5         | –                      | –               | ±0.1                   | –                                 | ±1.0                   | μA    |
| I <sub>OFF</sub> | Power Off Leakage Current | V <sub>IN</sub> = 5.5 V or V <sub>OUT</sub> = 5.5 V  | 0                   | –                      | –               | 1.0                    | –                                 | 10                     | μA    |
| I <sub>CC</sub>  | Quiescent Supply Current  | V <sub>IN</sub> = V <sub>CC</sub> or GND             | 5.5                 | –                      | –               | 1.0                    | –                                 | 10                     | μA    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

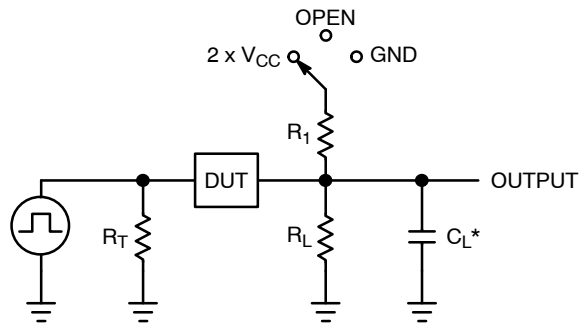
## AC ELECTRICAL CHARACTERISTICS

| Symbol                                 | Parameter                                       | Condition                                      | V <sub>CC</sub> (V) | T <sub>A</sub> = 25 °C |     |     | - 55 °C ≤ T <sub>A</sub> ≤ 125 °C |      | Units |
|----------------------------------------|-------------------------------------------------|------------------------------------------------|---------------------|------------------------|-----|-----|-----------------------------------|------|-------|
|                                        |                                                 |                                                |                     | Min                    | Typ | Max | Min                               | Max  |       |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Propagation Delay<br>A to Y<br>(Figure 3 and 4) | R <sub>L</sub> = 1 MΩ, C <sub>L</sub> = 15 pF  | 1.65 to 1.95        | –                      | 2.3 | 9.2 | –                                 | 11.0 | ns    |
|                                        |                                                 | R <sub>L</sub> = 1 MΩ, C <sub>L</sub> = 15 pF  | 2.3 to 2.7          | –                      | 3.0 | 5.1 | –                                 | 5.6  |       |
|                                        |                                                 | R <sub>L</sub> = 1 MΩ, C <sub>L</sub> = 15 pF  | 3.0 to 3.6          | –                      | 2.2 | 3.4 | –                                 | 3.8  |       |
|                                        |                                                 | R <sub>L</sub> = 500 Ω, C <sub>L</sub> = 50 pF |                     | –                      | 2.9 | 4.5 | –                                 | 5.0  |       |
|                                        |                                                 | R <sub>L</sub> = 1 MΩ, C <sub>L</sub> = 15 pF  | 4.5 to 5.5          | –                      | 1.8 | 2.8 | –                                 | 3.1  |       |
|                                        |                                                 | R <sub>L</sub> = 500 Ω, C <sub>L</sub> = 50 pF |                     | –                      | 2.3 | 3.6 | –                                 | 4.0  |       |

## CAPACITIVE CHARACTERISTICS

| Symbol           | Parameter                                 | Condition                                                                 | Typical | Units |
|------------------|-------------------------------------------|---------------------------------------------------------------------------|---------|-------|
| C <sub>IN</sub>  | Input Capacitance                         | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub>         | 2.5     | pF    |
| C <sub>OUT</sub> | Output Capacitance                        | V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub>         | 4.0     | pF    |
| C <sub>PD</sub>  | Power Dissipation Capacitance<br>(Note 5) | 10 MHz, V <sub>CC</sub> = 5.5 V, V <sub>IN</sub> = 0 V or V <sub>CC</sub> | 4.0     | pF    |

5. C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: I<sub>CC(OPR)</sub> = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>in</sub> + I<sub>CC</sub>. C<sub>PD</sub> is used to determine the no-load dynamic power consumption; P<sub>D</sub> = C<sub>PD</sub> • V<sub>CC</sub><sup>2</sup> • f<sub>in</sub> + I<sub>CC</sub> • V<sub>CC</sub>.



$C_L$  includes probe and jig capacitance  
 $R_T$  is  $Z_{OUT}$  of pulse generator (typically 50  $\Omega$ )  
 $f = 1$  MHz

Figure 3. Test Circuit

| Test                | Switch Position   | $C_L$ , pF                   | $R_L$ , $\Omega$ | $R_1$ , $\Omega$ |
|---------------------|-------------------|------------------------------|------------------|------------------|
| $t_{PLH} / t_{PHL}$ | Open              | See AC Characteristics Table |                  |                  |
| $t_{PLZ} / t_{PZL}$ | $2 \times V_{CC}$ | 50                           | 500              | 500              |
| $t_{PHZ} / t_{PZH}$ | GND               | 50                           | 500              | 500              |

X = Don't Care

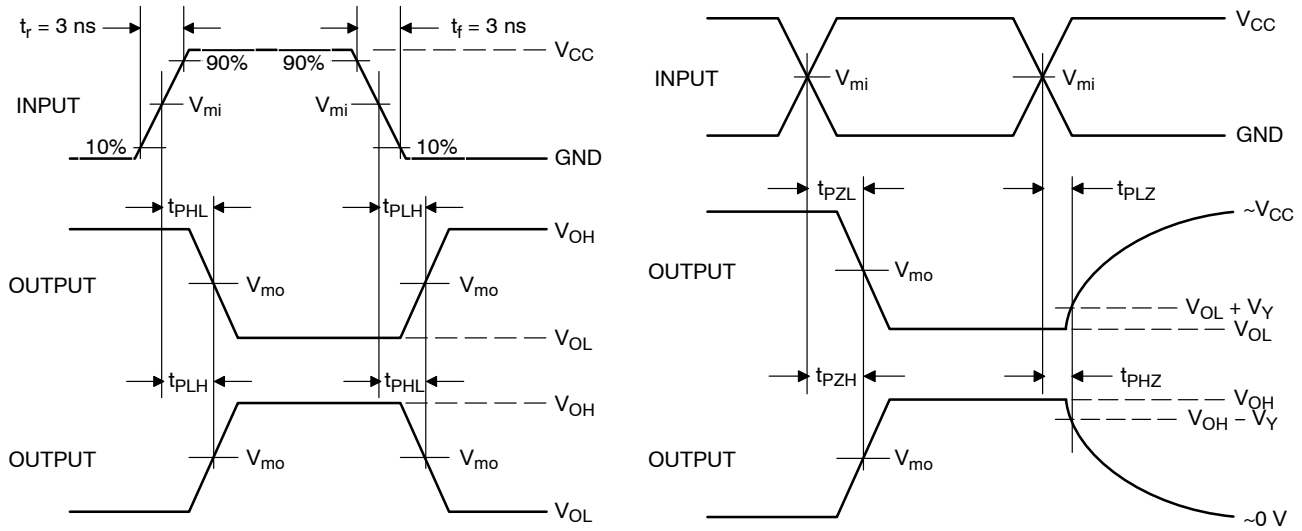


Figure 4. Switching Waveforms

| $V_{CC}$ , V | $V_{mi}$ , V | $V_{mo}$ , V       |                                      | $V_Y$ , V |
|--------------|--------------|--------------------|--------------------------------------|-----------|
|              |              | $t_{PLH}, t_{PHL}$ | $t_{PZL}, t_{PLZ}, t_{PZH}, t_{PHZ}$ |           |
| 1.65 to 1.95 | $V_{CC}/2$   | $V_{CC}/2$         | $V_{CC}/2$                           | 0.15      |
| 2.3 to 2.7   | $V_{CC}/2$   | $V_{CC}/2$         | $V_{CC}/2$                           | 0.15      |
| 3.0 to 3.6   | $V_{CC}/2$   | $V_{CC}/2$         | $V_{CC}/2$                           | 0.3       |
| 4.5 to 5.5   | $V_{CC}/2$   | $V_{CC}/2$         | $V_{CC}/2$                           | 0.3       |

# NL27WZ04

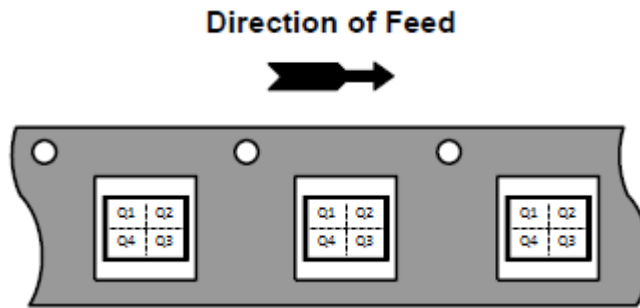
## DEVICE ORDERING INFORMATION

| Device                                            | Packages                | Specific Device Code   | Pin 1 Orientation<br>(See below) | Shipping <sup>†</sup> |
|---------------------------------------------------|-------------------------|------------------------|----------------------------------|-----------------------|
| NL27WZ04DFT2G                                     | SC-88                   | M5                     | Q4                               | 3000 / Tape & Reel    |
| NL27WZ04DFT2G-Q*                                  | SC-88                   | M5                     | Q4                               | 3000 / Tape & Reel    |
| NL27WZ04DFT1G                                     | SC-88                   | M5                     | Q2                               | 3000 / Tape & Reel    |
| NL27WZ04DFT1G-Q*                                  | SC-88                   | M5                     | Q2                               | 3000 / Tape & Reel    |
| NL27WZ04DBVT1G                                    | SC-74                   | M5                     | Q4                               | 3000 / Tape & Reel    |
| NL27WZ04MU1TCG                                    | UDFN6, 1.45 x 1.0, 0.5P | 2<br>(Rotated 90° CW)  | Q4                               | 3000 / Tape & Reel    |
| NL27WZ04MU3TCG<br>(Please contact <b>onsemi</b> ) | UDFN6, 1.0 x 1.0, 0.35P | E<br>(Rotated 180° CW) | Q4                               | 3000 / Tape & Reel    |

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, [BRD8011/D](#).

\* -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

### Pin 1 Orientation in Tape and Reel



**REVISION HISTORY**

| Revision | Description of Changes                                                                                                                                                                                | Date      |
|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|
| 15       | Update of High- and Low-Level Output Voltage Conditions in DC Electrical Characteristics table on p.4 ( $I_{OH}$ changed from $-3\text{ mA}$ and $3\text{ mA}$ to $-4\text{ mA}$ and $4\text{ mA}$ ). | 8/22/2025 |

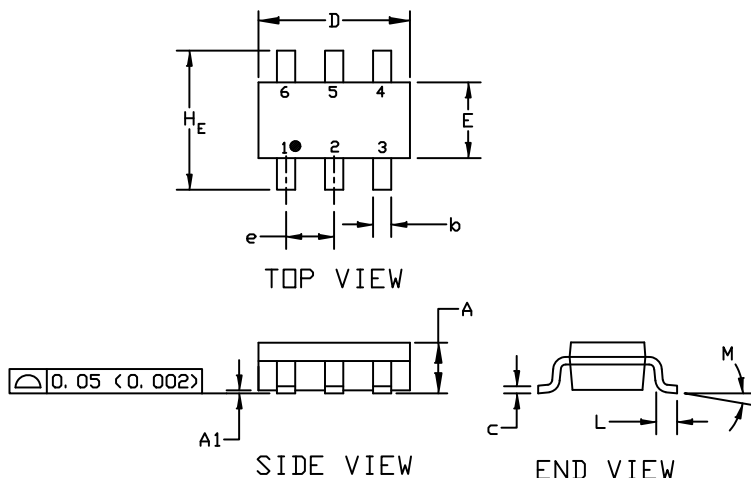
This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.



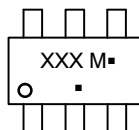
SCALE 2:1

SC-74  
CASE 318F  
ISSUE P

DATE 07 OCT 2021



GENERIC  
MARKING DIAGRAM\*



XXX = Specific Device Code  
M = Date Code  
▪ = Pb-Free Package

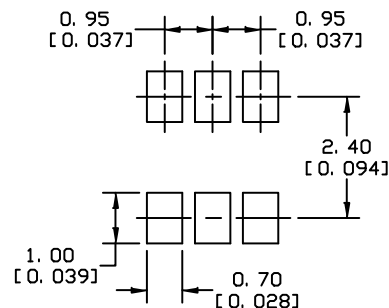
(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
2. CONTROLLING DIMENSION: INCHES
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.

| DIM            | MILLIMETERS |      |      | INCHES |       |       |
|----------------|-------------|------|------|--------|-------|-------|
|                | MIN.        | NOM. | MAX. | MIN.   | NOM.  | MAX.  |
| A              | 0.90        | 1.00 | 1.10 | 0.035  | 0.039 | 0.043 |
| A1             | 0.01        | 0.06 | 0.10 | 0.001  | 0.002 | 0.004 |
| b              | 0.25        | 0.37 | 0.50 | 0.010  | 0.015 | 0.020 |
| c              | 0.10        | 0.18 | 0.26 | 0.004  | 0.007 | 0.010 |
| D              | 2.90        | 3.00 | 3.10 | 0.114  | 0.118 | 0.122 |
| E              | 1.30        | 1.50 | 1.70 | 0.051  | 0.059 | 0.067 |
| e              | 0.85        | 0.95 | 1.05 | 0.034  | 0.037 | 0.041 |
| H <sub>E</sub> | 2.50        | 2.75 | 3.00 | 0.099  | 0.108 | 0.118 |
| L              | 0.20        | 0.40 | 0.60 | 0.008  | 0.016 | 0.024 |
| M              | 0*          | ---  | 10*  | 0*     | ---   | 10*   |



\* For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

SOLDERING FOOTPRINT

|                                                                                                         |                                                                                                                      |                                                                                                                   |                                                                                                                                                |                                                                                                               |                                                                                                       |
|---------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------|
| <b>STYLE 1:</b><br>PIN 1. CATHODE<br>2. ANODE<br>3. CATHODE<br>4. CATHODE<br>5. ANODE<br>6. CATHODE     | <b>STYLE 2:</b><br>PIN 1. NO CONNECTION<br>2. COLLECTOR<br>3. EMITTER<br>4. NO CONNECTION<br>5. COLLECTOR<br>6. BASE | <b>STYLE 3:</b><br>PIN 1. EMITTER 1<br>2. BASE 1<br>3. COLLECTOR 2<br>4. EMITTER 2<br>5. BASE 2<br>6. COLLECTOR 1 | <b>STYLE 4:</b><br>PIN 1. COLLECTOR 2<br>2. EMITTER 1/EMITTER 2<br>3. COLLECTOR 1<br>4. EMITTER 3<br>5. BASE 1/BASE 2/COLLECTOR 3<br>6. BASE 3 | <b>STYLE 5:</b><br>PIN 1. CHANNEL 1<br>2. ANODE<br>3. CHANNEL 2<br>4. CHANNEL 3<br>5. CATHODE<br>6. CHANNEL 4 | <b>STYLE 6:</b><br>PIN 1. CATHODE<br>2. ANODE<br>3. CATHODE<br>4. CATHODE<br>5. CATHODE<br>6. CATHODE |
| <b>STYLE 7:</b><br>PIN 1. SOURCE 1<br>2. GATE 1<br>3. DRAIN 2<br>4. SOURCE 2<br>5. GATE 2<br>6. DRAIN 1 | <b>STYLE 8:</b><br>PIN 1. EMITTER 1<br>2. BASE 2<br>3. COLLECTOR 2<br>4. EMITTER 2<br>5. BASE 1<br>6. COLLECTOR 1    | <b>STYLE 9:</b><br>PIN 1. EMITTER 2<br>2. BASE 2<br>3. COLLECTOR 1<br>4. EMITTER 1<br>5. BASE 1<br>6. COLLECTOR 2 | <b>STYLE 10:</b><br>PIN 1. ANODE/CATHODE<br>2. BASE<br>3. EMITTER<br>4. COLLECTOR<br>5. ANODE<br>6. CATHODE                                    | <b>STYLE 11:</b><br>PIN 1. EMITTER<br>2. BASE<br>3. ANODE/CATHODE<br>4. ANODE<br>5. CATHODE<br>6. COLLECTOR   |                                                                                                       |

|                         |                    |                                                                                                                                                                                     |
|-------------------------|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>DOCUMENT NUMBER:</b> | <b>98ASB42973B</b> | Electronic versions are uncontrolled except when accessed directly from the Document Repository.<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| <b>DESCRIPTION:</b>     | <b>SC-74</b>       | <b>PAGE 1 OF 1</b>                                                                                                                                                                  |

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.



SC-88 2.00x1.25x0.90, 0.65P  
CASE 419B-02  
ISSUE Z

DATE 18 APR 2024

NOTES:

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
2. ALL DIMENSION ARE IN MILLIMETERS.
3. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
4. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H.
5. DATUMS A AND B ARE DETERMINED AT DATUM H.
6. DIMENSIONS b AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
7. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION b AT MAXIMUM MATERIAL CONDITION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.



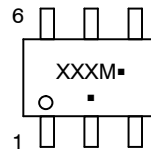
| DIM | MILLIMETERS |      |      |
|-----|-------------|------|------|
|     | MIN.        | NOM. | MAX. |
| A   | ---         | ---  | 1.10 |
| A1  | 0.00        | ---  | 0.10 |
| A2  | 0.70        | 0.90 | 1.00 |
| b   | 0.15        | 0.20 | 0.25 |
| c   | 0.08        | 0.15 | 0.22 |
| D   | 2.00 BSC    |      |      |
| E   | 2.10 BSC    |      |      |
| E1  | 1.25 BSC    |      |      |
| e   | 0.65 BSC    |      |      |
| L   | 0.26        | 0.36 | 0.46 |
| L2  | 0.15 BSC    |      |      |
| aaa | 0.15        |      |      |
| bbb | 0.30        |      |      |
| ccc | 0.10        |      |      |
| ddd | 0.10        |      |      |



RECOMMENDED MOUNTING FOOTPRINT\*

\* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ONSEMI SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

GENERIC  
MARKING DIAGRAM\*



XXX = Specific Device Code  
M = Date Code\*  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

STYLES ON PAGE 2

|                  |                             |                                                                                                                                                                                  |
|------------------|-----------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DOCUMENT NUMBER: | 98ASB42985B                 | Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| DESCRIPTION:     | SC-88 2.00x1.25x0.90, 0.65P | PAGE 1 OF 2                                                                                                                                                                      |

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

SC-88 2.00x1.25x0.90, 0.65P  
CASE 419B-02  
ISSUE Z

DATE 18 APR 2024

|                                                                                                            |                                                                                                        |                                                                                                             |                                                                                                             |                                                                                                             |                                                                                                       |
|------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------|
| STYLE 1:<br>PIN 1. EMITTER 2<br>2. BASE 2<br>3. COLLECTOR 1<br>4. EMITTER 1<br>5. BASE 1<br>6. COLLECTOR 2 | STYLE 2:<br>CANCELLED                                                                                  | STYLE 3:<br>CANCELLED                                                                                       | STYLE 4:<br>PIN 1. CATHODE<br>2. CATHODE<br>3. COLLECTOR<br>4. EMITTER<br>5. BASE<br>6. ANODE               | STYLE 5:<br>PIN 1. ANODE<br>2. ANODE<br>3. COLLECTOR<br>4. EMITTER<br>5. BASE<br>6. CATHODE                 | STYLE 6:<br>PIN 1. ANODE 2<br>2. N/C<br>3. CATHODE 1<br>4. ANODE 1<br>5. N/C<br>6. CATHODE 2          |
| STYLE 7:<br>PIN 1. SOURCE 2<br>2. DRAIN 2<br>3. GATE 1<br>4. SOURCE 1<br>5. DRAIN 1<br>6. GATE 2           | STYLE 8:<br>CANCELLED                                                                                  | STYLE 9:<br>PIN 1. EMITTER 2<br>2. EMITTER 1<br>3. COLLECTOR 1<br>4. BASE 1<br>5. BASE 2<br>6. COLLECTOR 2  | STYLE 10:<br>PIN 1. SOURCE 2<br>2. SOURCE 1<br>3. GATE 1<br>4. DRAIN 1<br>5. DRAIN 2<br>6. GATE 2           | STYLE 11:<br>PIN 1. CATHODE 2<br>2. CATHODE 2<br>3. ANODE 1<br>4. CATHODE 1<br>5. CATHODE 1<br>6. ANODE 2   | STYLE 12:<br>PIN 1. ANODE 2<br>2. ANODE 2<br>3. CATHODE 1<br>4. ANODE 1<br>5. ANODE 1<br>6. CATHODE 2 |
| STYLE 13:<br>PIN 1. ANODE<br>2. N/C<br>3. COLLECTOR<br>4. EMITTER<br>5. BASE<br>6. CATHODE                 | STYLE 14:<br>PIN 1. VREF<br>2. GND<br>3. GND<br>4. IOUT<br>5. VEN<br>6. VCC                            | STYLE 15:<br>PIN 1. ANODE 1<br>2. ANODE 2<br>3. ANODE 3<br>4. CATHODE 3<br>5. CATHODE 2<br>6. CATHODE 1     | STYLE 16:<br>PIN 1. BASE 1<br>2. EMITTER 2<br>3. COLLECTOR 2<br>4. BASE 2<br>5. EMITTER 1<br>6. COLLECTOR 1 | STYLE 17:<br>PIN 1. BASE 1<br>2. EMITTER 1<br>3. COLLECTOR 2<br>4. BASE 2<br>5. EMITTER 2<br>6. COLLECTOR 1 | STYLE 18:<br>PIN 1. VIN1<br>2. VCC<br>3. VOUT2<br>4. VIN2<br>5. GND<br>6. VOUT1                       |
| STYLE 19:<br>PIN 1. I OUT<br>2. GND<br>3. GND<br>4. V CC<br>5. V EN<br>6. V REF                            | STYLE 20:<br>PIN 1. COLLECTOR<br>2. COLLECTOR<br>3. BASE<br>4. EMITTER<br>5. COLLECTOR<br>6. COLLECTOR | STYLE 21:<br>PIN 1. ANODE 1<br>2. N/C<br>3. ANODE 2<br>4. CATHODE 2<br>5. N/C<br>6. CATHODE 1               | STYLE 22:<br>PIN 1. D1 (i)<br>2. GND<br>3. D2 (i)<br>4. D2 (c)<br>5. VBUS<br>6. D1 (c)                      | STYLE 23:<br>PIN 1. Vn<br>2. CH1<br>3. Vp<br>4. N/C<br>5. CH2<br>6. N/C                                     | STYLE 24:<br>PIN 1. CATHODE<br>2. ANODE<br>3. CATHODE<br>4. CATHODE<br>5. CATHODE<br>6. CATHODE       |
| STYLE 25:<br>PIN 1. BASE 1<br>2. CATHODE<br>3. COLLECTOR 2<br>4. BASE 2<br>5. EMITTER<br>6. COLLECTOR 1    | STYLE 26:<br>PIN 1. SOURCE 1<br>2. GATE 1<br>3. DRAIN 2<br>4. SOURCE 2<br>5. GATE 2<br>6. DRAIN 1      | STYLE 27:<br>PIN 1. BASE 2<br>2. BASE 1<br>3. COLLECTOR 1<br>4. EMITTER 1<br>5. EMITTER 2<br>6. COLLECTOR 2 | STYLE 28:<br>PIN 1. DRAIN<br>2. DRAIN<br>3. GATE<br>4. SOURCE<br>5. DRAIN<br>6. DRAIN                       | STYLE 29:<br>PIN 1. ANODE<br>2. ANODE<br>3. COLLECTOR<br>4. EMITTER<br>5. BASE/ANODE<br>6. CATHODE          | STYLE 30:<br>PIN 1. SOURCE 1<br>2. DRAIN 2<br>3. DRAIN 2<br>4. SOURCE 2<br>5. GATE 1<br>6. DRAIN 1    |

Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

|                  |                             |                                                                                                                                                                                     |
|------------------|-----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DOCUMENT NUMBER: | 98ASB42985B                 | Electronic versions are uncontrolled except when accessed directly from the Document Repository.<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| DESCRIPTION:     | SC-88 2.00x1.25x0.90, 0.65P | PAGE 2 OF 2                                                                                                                                                                         |

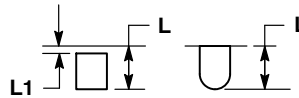
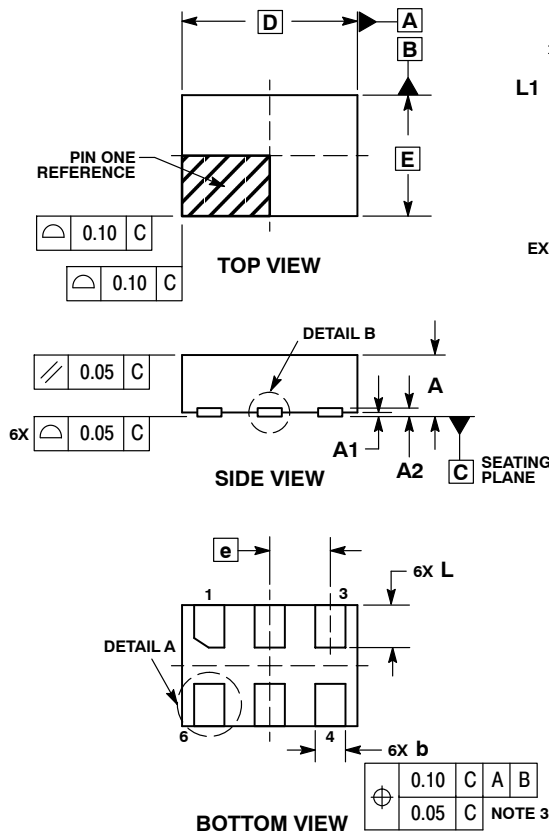
onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.



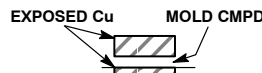
SCALE 4:1

UDFN6, 1.45x1.0, 0.5P  
CASE 517AQ  
ISSUE O

DATE 15 MAY 2008



DETAIL A  
OPTIONAL  
CONSTRUCTIONS



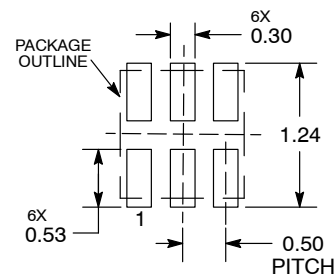
DETAIL B  
OPTIONAL  
CONSTRUCTIONS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.

| MILLIMETERS |          |      |
|-------------|----------|------|
| DIM         | MIN      | MAX  |
| A           | 0.45     | 0.55 |
| A1          | 0.00     | 0.05 |
| A2          | 0.07 REF |      |
| b           | 0.20     | 0.30 |
| D           | 1.45 BSC |      |
| E           | 1.00 BSC |      |
| e           | 0.50 BSC |      |
| L           | 0.30     | 0.40 |
| L1          | ---      | 0.15 |

MOUNTING FOOTPRINT



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC  
MARKING DIAGRAM\*



X = Specific Device  
Code

M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking.  
Pb-Free indicator, "G" or microdot "▪", may or may not be present.

|                  |                       |                                                                                                                                                                                     |
|------------------|-----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DOCUMENT NUMBER: | 98AON30313E           | Electronic versions are uncontrolled except when accessed directly from the Document Repository.<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| DESCRIPTION:     | UDFN6, 1.45x1.0, 0.5P | PAGE 1 OF 1                                                                                                                                                                         |

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.



SCALE 4:1

UDFN6, 1x1, 0.35P  
CASE 517BX  
ISSUE O

DATE 18 MAY 2011



## NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | 0.45 | 0.55 |
| A1          | 0.00 | 0.05 |
| A3          | 0.13 | REF  |
| b           | 0.12 | 0.22 |
| D           | 1.00 | BSC  |
| E           | 1.00 | BSC  |
| e           | 0.35 | BSC  |
| L           | 0.25 | 0.35 |
| L1          | 0.30 | 0.40 |

**RECOMMENDED  
SOLDERING FOOTPRINT\***


\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

**GENERIC  
MARKING DIAGRAM\***


X = Specific Device Code  
M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                         |                          |                                                                                                                                                                                     |
|-------------------------|--------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>DOCUMENT NUMBER:</b> | <b>98AON56787E</b>       | Electronic versions are uncontrolled except when accessed directly from the Document Repository.<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| <b>DESCRIPTION:</b>     | <b>UDFN6, 1x1, 0.35P</b> | <b>PAGE 1 OF 1</b>                                                                                                                                                                  |

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

**onsemi**, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## ADDITIONAL INFORMATION

### TECHNICAL PUBLICATIONS:

Technical Library: [www.onsemi.com/design/resources/technical-documentation](http://www.onsemi.com/design/resources/technical-documentation)  
onsemi Website: [www.onsemi.com](http://www.onsemi.com)

### ONLINE SUPPORT: [www.onsemi.com/support](http://www.onsemi.com/support)

For additional information, please contact your local Sales Representative at  
[www.onsemi.com/support/sales](http://www.onsemi.com/support/sales)